



DMG1026UVQ

60V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(on)	I _D T _A = +25°C
60V	1.8Ω @ V _{GS} = 10V	440mA
600	2.1Ω @ V _{GS} = 4.5V	410mA

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Battery operated systems and solid-state relays
- Drivers: relays, solenoids, lamps, hammers, displays, memories, transistors, etc.
- DC-DC converters
- Power-management functions

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMG1026UVQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

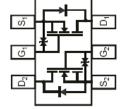
- Package: SOT563
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.003 grams (Approximate)

SOT563









Top View

Bottom View

Top View Pin Definition/Schematic

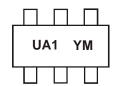
Ordering Information (Note 4)

Part Number	Paskaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMG1026UVQ-7	SOT563	3,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



UA1 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: L = 2024) M = Month (ex: 9 = September)

Date Code Key

Bate Gode Ney												
Year	2015	-	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	С	-	L	М	N	Р	R	S	Т	U	V	W
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characterist	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	60	V		
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +85°C	ID	410 300	mA
Continuous Drain Current (Note 6) V _{GS} = 10V	t ≤ 10s	T _A = +25°C T _A = +85°C	ID	440 320	mA
Continuous Drain Current (Note 5) V _{GS} = 4.5V	Steady State	T _A = +25°C T _A = +85°C	ID	380 270	mA
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t ≤ 10s	T _A = +25°C T _A = +85°C	ID	410 295	mA
Pulsed Drain Current (Note 7)	IDM	1.0	Α		

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Power Dissipation (Note 5)	PD	0.58	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	$R_{\theta JA}$	213	°C/W
Power Dissipation (Note 6) t ≤ 10s	PD	0.65	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6) t ≤ 10s	Reja	192	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

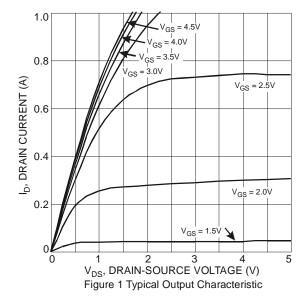
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

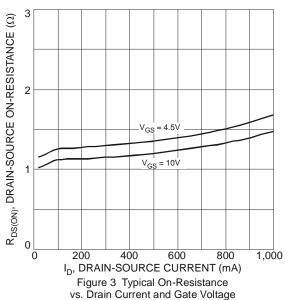
Characteristic	Symbol	Min	T. m	Max	Unit	Test Condition
***************************************	Symbol	IVIII	Тур	IVIAX	Unit	rest Condition
OFF CHARACTERISTICS (Note 8)			ı	ı		
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	IDSS		_	1.0	μΑ	$V_{DS} = 50V$, $V_{GS} = 0V$
Gate-Source Leakage	lana	_		±50	nA	$V_{GS} = \pm 5V$, $V_{DS} = 0V$
Gale-Source Leakage	I _{GSS}	_	_	±150	nA	$V_{GS} = \pm 10V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _G S(TH)	0.5	_	1.8	V	V _{DS} = V _{GS} , I _D = 250µA
Static Drain-Source On-Resistance	D	_	1.2	1.8	Ω	V _{GS} = 10V, I _D = 500mA
Static Drain-Source On-Resistance	R _{DS(ON)}	_	1.4	2.1	1 12	V _{GS} = 4.5V, I _D = 200mA
Forward Transfer Admittance	Y _{fs}	80	580	_	mS	V _{DS} = 10V, I _D = 200mA
Continuous Source Current (Note 8)	Is	_	_	200	mA	_
Diode Forward Voltage	V _{SD}	_	0.8	1.3	V	V _{GS} = 0V, I _S = 200mA
DYNAMIC CHARACTERISTICS (Note 9)	<u> </u>					
Input Capacitance	Ciss	_	32	_		
Output Capacitance	Coss	_	4.4	_	pF	$V_{DS} = 25V$, $V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	2.9	_		T = T.OIVITIZ
Gate Resistance	Rg	_	126	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge	Qg		0.45	_		
Gate-Source Charge	Qgs		0.08	_	рC	$V_{GS} = 4.5V, V_{DS} = 10V$ $I_{D} = 250 \text{mA}$
Gate-Drain Charge	Qgd	_	0.08	_		ID = 250MA
Turn-On Delay Time	tD(ON)	_	3.4	_	ns	
Turn-On Rise Time	t _R	_	3.4	_	ns	$V_{GS} = 10V, V_{DS} = 30V$
Turn-Off Delay Time	tD(OFF)	tD(OFF) — 26.4 —		_	ns	$R_L = 150\Omega, R_g = 25\Omega$ $R_D = 200 \text{mA}$
Turn-Off Fall Time	t _F	_	16.3	_	ns	ID = ZUUIIA

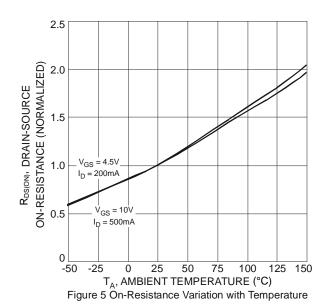
Notes:

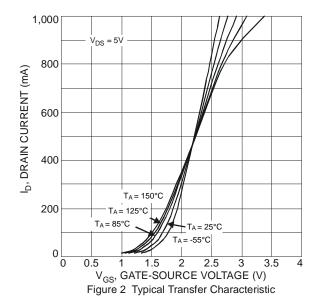
- 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 PCB with minimum recommended pad layout, measured in t ≤ 10s.
- 7. Repetitive rating, pulse width limited by junction temperature, 10µs pulse, duty cycle = 1%.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.

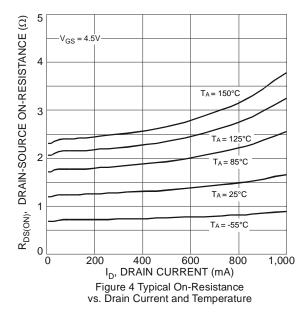


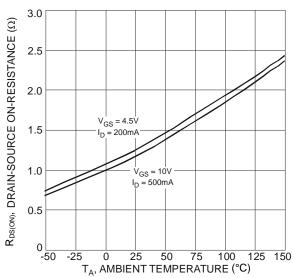














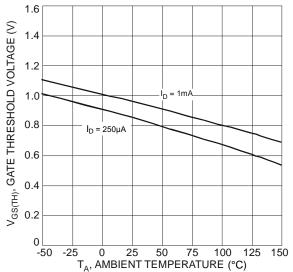
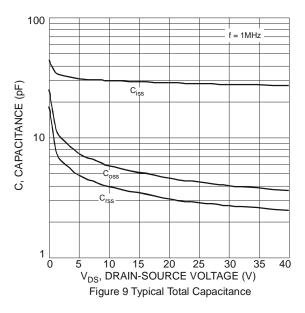
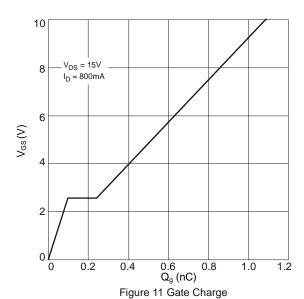
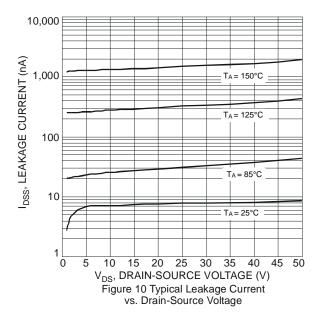
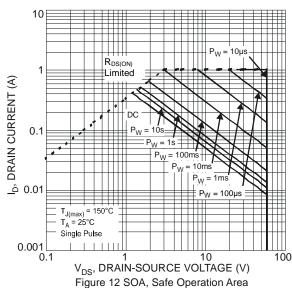


Figure 7 Gate Threshold Variation vs. Ambient Temperature











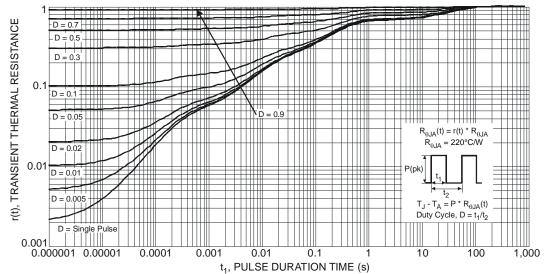


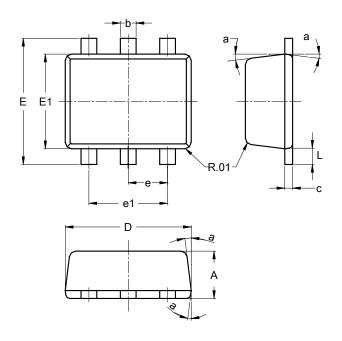
Figure 13 Transient Thermal Response



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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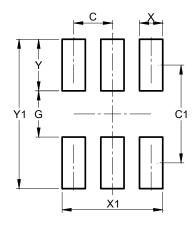


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Dim	Min	Max	Тур			
Α	0.55	0.60				
b	0.15	0.30	0.20			
С	0.10	0.18	0.11			
D	1.50	1.70	1.60			
Е	1.55	1.70	1.60			
E1	1.10	1.25	1.20			
е			0.50			
e1	0.90	1.10	1.00			
L	0.10	0.30	0.20			
а	8°	9°	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

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Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
Y1	1.940



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